

HEADERS & RECEPTACLES





PRODUCT DRAWING



♣ 3D PDF

TE CONNECTIVITY (TE)

04 MTE HDR SRST LATCH W/HLDWN

AMPMODU | AMPMODU MTE

5-104362-3

TE Internal Number: 5-104362-3

Always EU RoHS/ELV Compliant

Centerline 2.54 mm [.1 in]

Number of Positions 4

PCB Mounting Orientation Vertical

PCB Mounting Style Through Hole (SMT Compatible)

Number of Rows 1

Product Drawings

HEADER ASSY, AMPMODU MTE, VERTICAL SINGLE ROW, .100 C/L, .025 SQ

POST POLARIZED, WITH LATCHING & HOLD DOWN

PDF English

CAD Files

3D PDF

PDF **English**

Customer View Model

2D_DXF.ZIP

English

Customer View Model

3D_IGS.ZIP

English

Customer View Model

3D_STP.ZIP English

Catalog Pages/Data Sheets

AMPMODU_INTERCONNECTION_SYSTEM_SECTION5_CONT

PDF **English**

AMP MODU MTE Section Of Catalog 1307819

PDF **English**

AMPMODU MTE INTERCONNECT SYSTEM

PDF **English**

Product Specifications

Application Specification AMPMODU MTE Interconnection System

PDF **English**

Product Environmental Compliance

TE Material Declaration MD_5-104362-3_05302013653_dmtec

PDF ...

English

Please review product documents or contact us for the latest agency approval information. Please Note: Use the Product Drawing for all design activity.

Product Type Features	PCB Mounting Orientation	Vertical
Troduct Type realules		Connector
	Product Type	
	Connector Type	Header
	Strain Relief	Without
	Row-to-Row Spacing	2.54 mm [.1 in]
	Connector Style	Plug
	PCB Orientation Feature	No
	Applies To	Printed Circuit Board
Configuration Features	Number of Positions	4
	Number of Rows	1
	Backwall/Post Interruptions	Without
Electrical Characteristics	Dielectric Withstanding Voltage	600 V
	Insulation Resistance	5000 ΜΩ
	Termination Resistance	15 ΜΩ
Body Features	Header Type	Shrouded
Body Features Contact Features	Header Type Contact Mating Area Plating Material	Shrouded
	Contact Mating Area Plating Material	Gold
	Contact Mating Area Plating Material Contact Mating Area Plating Thickness (µin)	Gold 15
	Contact Mating Area Plating Material Contact Mating Area Plating Thickness (µin) Contact Termination Area Plating Thickness	Gold 15 2.54 – 5.08 μm [100 – 200 μin]
	Contact Mating Area Plating Material Contact Mating Area Plating Thickness (µin) Contact Termination Area Plating Thickness Contact Shape	Gold 15 2.54 – 5.08 μm [100 – 200 μin] Square
	Contact Mating Area Plating Material Contact Mating Area Plating Thickness (µin) Contact Termination Area Plating Thickness Contact Shape Tail Plating Material	Gold 15 2.54 – 5.08 μm [100 – 200 μin] Square Tin
	Contact Mating Area Plating Material Contact Mating Area Plating Thickness (µin) Contact Termination Area Plating Thickness Contact Shape Tail Plating Material Contact Termination Area Plating Material	Gold 15 2.54 – 5.08 μm [100 – 200 μin] Square Tin Tin
	Contact Mating Area Plating Material Contact Mating Area Plating Thickness (µin) Contact Termination Area Plating Thickness Contact Shape Tail Plating Material Contact Termination Area Plating Material Tail Plating Thickness	Gold 15 2.54 – 5.08 μm [100 – 200 μin] Square Tin Tin 2.54 – 5.08 μm [100 – 200 μin]
	Contact Mating Area Plating Material Contact Mating Area Plating Thickness (µin) Contact Termination Area Plating Thickness Contact Shape Tail Plating Material Contact Termination Area Plating Material Tail Plating Thickness Contact Type	Gold 15 2.54 – 5.08 μm [100 – 200 μin] Square Tin Tin 2.54 – 5.08 μm [100 – 200 μin] Pin
	Contact Mating Area Plating Material Contact Mating Area Plating Thickness (µin) Contact Termination Area Plating Thickness Contact Shape Tail Plating Material Contact Termination Area Plating Material Tail Plating Thickness Contact Type Solder Tail Contact Plating Material	Gold 15 2.54 – 5.08 μm [100 – 200 μin] Square Tin Tin 2.54 – 5.08 μm [100 – 200 μin] Pin Tin
	Contact Mating Area Plating Material Contact Mating Area Plating Thickness (µin) Contact Termination Area Plating Thickness Contact Shape Tail Plating Material Contact Termination Area Plating Material Tail Plating Thickness Contact Type Solder Tail Contact Plating Material Solder Tail Contact Plating Material Finish	Gold 15 2.54 – 5.08 μm [100 – 200 μin] Square Tin Tin 2.54 – 5.08 μm [100 – 200 μin] Pin Tin Matte

Termination Features	Termination Method to Wire/Cable	Crimp, Insulation Displacement Crimp (ID
Mechanical Attachment	PCB Mounting Style	Through Hole (SMT Compatible)
	PCB Mount Alignment	Without
	Mating Retention	With
	PCB Mount Retention	With
	PCB Mount Retention Type	Hold-Down
	Contact Retention	With
	Mating Alignment Type	Latched
	Contact Retention Type	Locking Lance
	Mating Retention Type	Hold-Down
	Mating Alignment	With
Housing Features	Centerline	2.54 mm [.1 in]
	Housing Color	Black
	Housing Material	Thermoplastic
Dimensions	Tail Length	3.3 mm [.13 in]
	Mating Post Length	5.84 mm [.23 in]
	PCB Thickness (Recommended)	1.58 mm [.062 in]
	Height	13.59 mm [.535 in]
	Length	12.7 mm [.5 in]
Jsage Conditions	Temperature Rating	High
	Operating Temperature Range (°C)	-65 – 105
Operation/Application	For Use With	Receptacle Housing Assembly
	Pick and Place Cover	Without
ndustry Standards	UL Flammability Rating	UL 94V-0
	Approved Standards	CSA LR7189, UL E28476
Packaging Features	Packaging Method	Tube, Tube/Box
	Packaging Quantity	42

Product Compliance

Statement of Compliance

VIEW ALL PRODUCT COMPLIANCE

CUSTOMERS ALSO BOUGHT

